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#### General Information

Series	KONNEKT KC-LINK Comm COG
Style	KONNEKT
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss
RoHS	Yes
Termination	Tin
AEC-Q200	No
Typical Component Weight	300 mg
Notes	2-Chip Standard Orientation.
Chip Size	1812-2
MSL	1

#### Specifications

Capacitance	0.094 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	500 VDC
Dielectric Withstanding Voltage	750 VDC
Temperature Range	-55/+150°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	10.6383 GOhms

#### Dimensions

L	4.5mm +/-0.3mm
W	3.2mm +/-0.3mm
T	5.1mm +/-0.4mm
B	0.6mm +/-0.35mm

#### Packaging Specifications

Packaging	T&R, 180mm
Packaging Quantity	200

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